ASSOCIATION CONNECTING LECTRANICS INDUSTRIES® INTERNATIONAL AND ADDRESS INDUSTRIES®	PC. Bannockb	ourn. Illinois. A	Il rights reserved untions.	nder both	This docum level parts, t	ent is a declaration er	on of the substancompasses all	ances within the manuf lower level materials f	acturer listed or which the	d item. Note: it e manufacturer	f the item is an as has engineering	ssembly with lower responsibility.		
				Form Type Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					on				
Supplier Information														
Company name* Com			Company unique ID			Unique ID Authority				Response Date*				
onsemi											2024-05-17			
Contact Name Title - Contact			ct		Phone - Contact	none - Contact*			Email - Contact*					
Product-Env-Stewards Product Env			Enviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repr			epresentative			Phone - Representative*			Emai	Email - Representative*				
Product-Env-Stewards Pr			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		r Mfr Item Name			Effective Date	Version	Manufacturing Sit	e	Weight*	UOM	Unit Type		
	MBR120	MBR120VLSFT1G REC SOD123 S		HTKY 1A 20V	7	2024-05-17 MY1		MY1	14.9		mg	Each		
Manufacturing Proccess Information	tion													
Terminal Plating / Grid Array Ma	Terminal Plating / Grid Array Material Terminal Base Alloy		Alloy J	-STD-020 MSI	L Rating	Peak Proce	ss Body Temp	erature Max Time at I	Peak Tempe	rature Numb	er of Reflow Cy	cles		
Matte Tin (Sn) - annealed CU Alloy			l		260	С	30	sec	conds 3					
Comments														
evel 1 - maximum time at peak temperatu	re during sol	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (Pl		dmium and quantity limit of 0.1% by mass (10 minated Diphenyl Ethers (PBDE), and Bis(2-et	
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).		
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the
Supplier Digital Signature	astislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select	the Level (IIG A IIG B	Requester or Supplier) [B	l select the subst	ance category (JIG or Requester) or enter a va	alue (Supplier) [C] se	elect the substance (II	G) or enter the substa	nce and CAS (Other) [D]
select a RoHS exemption, if applic	cable [E] enter the weigh	t of the substance or the P	PM concentration	[F] Optionally enter the positive (+) and neg	ative (-) tolerance in	percent (Note: percer	it tolerance values are	expected to cover a 3
sigma range of distribution unless	otherwise noted).							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	2.02	mg	Supplier	Zinc (Zn)	7440-66-6		0.0024	mg
			Supplier	Iron (Fe)	7439-89-6		0.0475	mg
			Supplier	Copper (Cu)	7440-50-8		1.9695	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0006	mg
Die	0.98	mg	Supplier	Silicon (Si)	7440-21-3		0.98	mg
Die Attach Solder	0.26	mg	Supplier	Silver (Ag)	7440-22-4		0.0065	mg
			А	Lead (Pb)	7439-92-1	7a	0.2405	mg
			Supplier	Tin (Sn)	7440-31-5		0.013	mg
Lead Frame	5.25	mg	Supplier	Zinc (Zn)	7440-66-6		0.0063	mg
			Supplier	Iron (Fe)	7439-89-6		0.1234	mg
			Supplier	Copper (Cu)	7440-50-8		5.1188	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0016	mg
Mold Compound-Black	5.79	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.579	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0289	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.8395	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.7635	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.579	mg
Plating	0.6	mg	Supplier	Tin (Sn)	7440-31-5		0.6	mg